Specifications for Approval

	Customer Part N	lo.:	
	Inhere Part No.:	LAMGB02793-R01	
	Part Name: 5mn	n 草帽头有边水清透明橙绿	是蓝三色共阳 LED
	Spec Issue Date:	2018-07-23	
	Revision No.: A		
=========			
■ Sample ■ Electrical			D Dimension Tagram
Prepared by: Date: 2018-0	•	Checked by: Tom Date: 2018-07-23	Approved by: Wangxiaojun Date: 2018-07-23
	pinion nd no objection h the following reas		=======================================



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SPECIFICATIONS

Features

- High speed response.
- High reliability and long life.
- Low power consumption.
- Available in red, orange, yellow, yellow-green, green, blue, white, pink*
- Suitable for pulse operation.
- RoHS compliant.

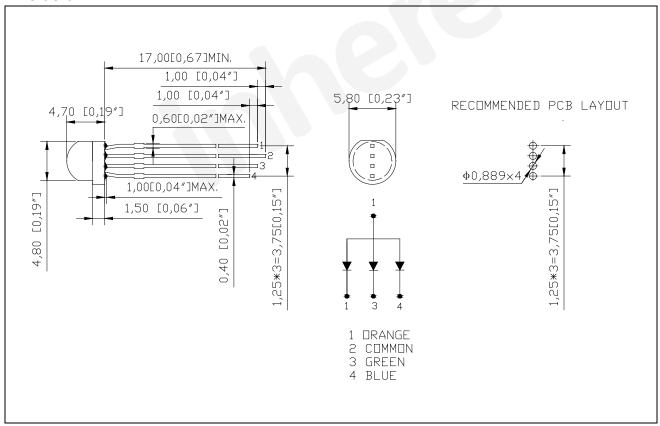
Description

- The Orange source color devices are made with AlGaInP on GaAs Light Emitting Diode.
- The Green source color devices are made with InGaN/GaN on Al₂O₃ Light Emitting Diode.
- The Blue source color devices are made with InGaN/GaN on Al₂O₃ Light Emitting Diode

Applications

- Consumer electronics
- Display boards
- Indicators

Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25 (0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Dice Emitting Color		I _V (mcd)	Viewing Angle(°)	
				Min.	Тур.	$2\theta_{\frac{1}{2}}$
LAMGB02793-R01	AlGaInP	Orange		200	400	
	InGaN/GaN	Green	Water Clear	1100	2000	90
	InGaN/GaN	Blue		1000	1800	

Note

- $1.\theta_{\frac{1}{2}}$ is the angle from optical centerline where the luminous intensity is $\frac{1}{2}$ the optical centerline value.
- 2. The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.

Electrical / Optical Characteristics (at $T_a = 25^{\circ}C$)

D	Symbol	Color	Value			11	o . !:::	
Parameter			Min.	Тур.	Max.	Unit	Test Condition	
Forward Voltage	$V_{\rm F}$	Orange	1.8		2.5	V		
		Green	2.7		3.5		I _F = 20mA	
		Blue	2.8		3.5			
Dominant Wavelength	$\lambda_{_{\mathrm{D}}}$	Orange	600		610	nm	I _F = 20mA	
		Green	520		530			
		Blue	460		470			
	I_R	Orange						
Reverse Current		Green			10	μΑ	$V_R = 5V$	
		Blue						

Note:

- 1. The tolerance of forward voltage is $\pm\,$ 0.05V.
- 2. The tolerance of dominant wavelength is ±1nm.
- 3. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

Absolute Maximum Ratings (at $T_a = 25$ °C)

Downston	Sumbal	Value			. I laste
Parameter	Symbol	0	G	В	Unit
Power Dissipation	P_{D}	75 105 105		105	mW
Pulse Forward Current(Duty 1/10 @ 1 kHz)	I_{FP}	100			mA
Forward Current	I_{F}	30			mA DC
Reverse Voltage	V_R	5			V DC
Operating Temperature	$T_{ m opr}$	-40 ~ +85		i	°C
Storage Temperature T_{stg} -40 \sim +85		i	°C		
Soldering Temperature	T _{sol}	260°C for 5 sec		or 5 sec	

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Reliability Testing Conditions

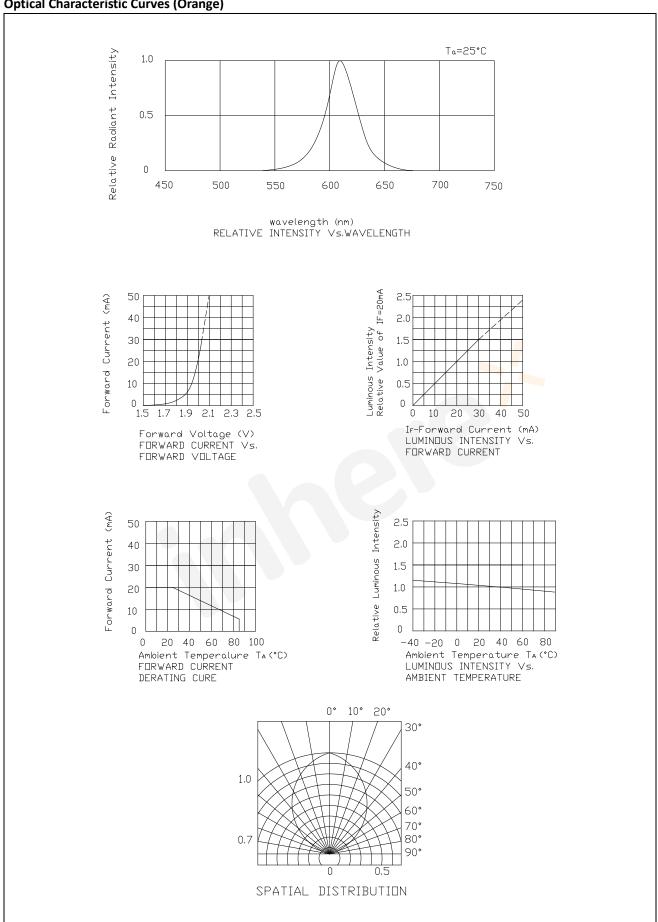
NO	Test Item	Test Conditions	Duration	Sample	Ac/Re
1	Temperature Cycle	-40°C±5°C~25°C±5°C~100°C±5°C~25°C±5°C 30min 5min 30min 5min	100cycles	22	0/1
2	High Temp. Storage	Ta=100℃ ±5℃	1000hours	22	0/1
3	Temp.& Humidity Test	Ta=85°C ±5°C RH=85% ±5%	1000hours	22	0/1
4	Low Temp. Storage	Ta=-40°C ±5°C	1000hours	22	0/1
5	Operating Life Test	Ta=25±5℃ DC IF=20mA	1000hours	22	0/1
6	Solder Heat	Tsol=260±5℃,5s	1times	22	0/1
7	Thermal Shock	-40±5°C →100±5°C 15min 15min	100cycles	22	0/1

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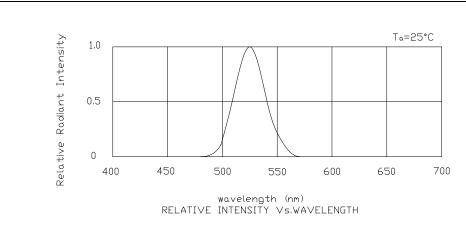
Prepared by: Lily

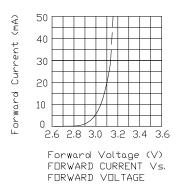
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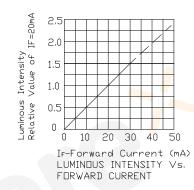
Optical Characteristic Curves (Orange)

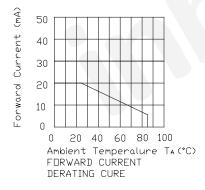


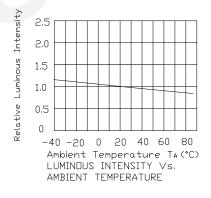
Optical Characteristic Curves (Green)

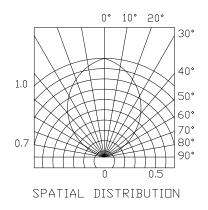








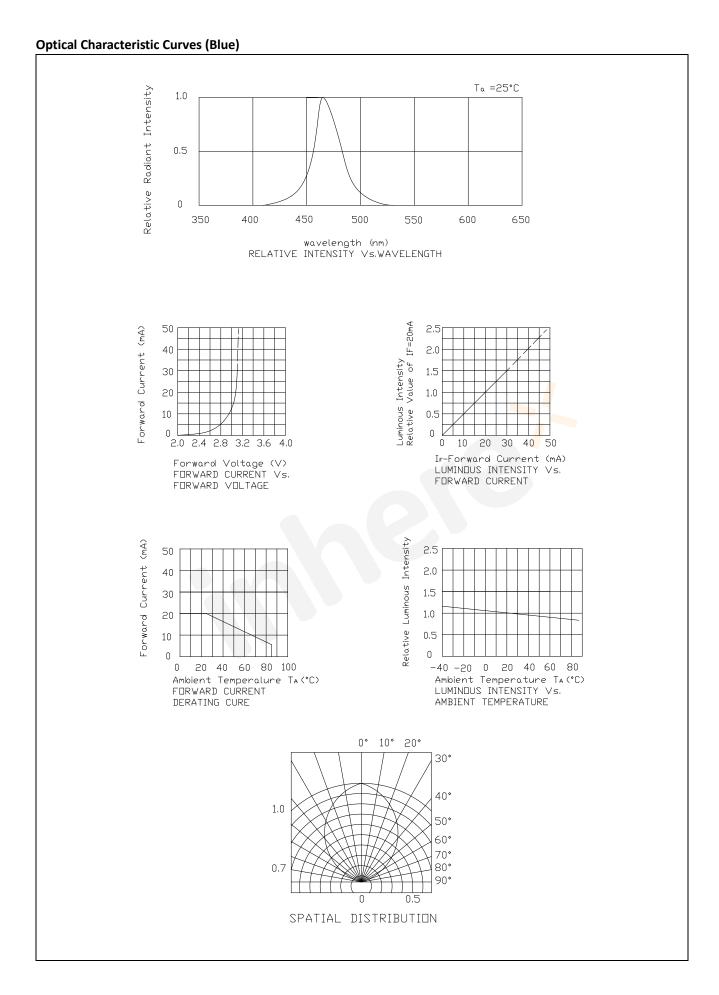




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Precautions in Use

1. Soldering Condition

- a. When soldering, leave the minimum clearance between the bottom of the resin and the soldering point.
- b. Do not solder closer than 3mm from the base of the epoxy bulb.
- c. Maximum allowance soldering conditions are:
 - Dip Soldering: 260°C max., 5 sec Max., 1 time.
 - Soldering iron: 350°C max., 5 sec Max., 1 time
- d. Contact between molten solder and the resin shall be avoided.
- e. During soldering, do not put any stress on the lead frame, particularly when heated.

2. Lead frame Forming and Use

- a. When forming leads, the leads shall be bent at a point at least 3mm from the base of epoxy bulb. Do not use the base of the lead frame as a fulcrum during lead forming.
- b. Lead forming shall be done before soldering.
- c. Do not apply any bending stress to the base of the lead. The stress to the base may damage the LED's characteristics or it may break the LED.
- d. When mounting the LED onto a printed circuit board, the holes on the PCB shall be exactly aligned with the leads of the LED. If the LED is mounted with stress at the leads, it may cause deterioration of the epoxy resin and this may degrade the LED.
- e. Avoid condition which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operation. It is recommended that the LED be used as soon as possible.
- f. Avoid rapid transition in ambient temperature, especially in high humidity environment.

3. Static Electricity

- a. The product is sensitive to static electricity charge, and user is required to handle it with care. Particularly, if a current and/or voltage which exceed the Absolute Maximum Rating of the Product is applied, the overflow in energy may cause damage to, or possibly result in electrical destruction of, the LED. The customer is requested to take adequate countermeasure against static electricity charge and surge when handling it.
- b. Proper grounding, use of conductive mat, conductive working uniform and shoes, and conductive containers are effective against static electricity and surge.
- c. Ground low-resistance area where the product contacts, such as metal surface of the work platform, with a conductive mat (surface resistance $10^6 \sim 10^9$ ohm).
- d. A tip of soldering iron is requested to be grounded. An ionizer shall also be installed where risk of static generation is high.

Notes:

- 1. The above specification and dimensions may be modified for product improvement. Inhere reserves the right to change the specification without notice.
- When using this product, please observe the Absolute Maximum Ratings and the instructions in the specification sheets. Inhere assumes no responsibility for any damage resulting from use of the product that does not comply with the instructions.

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